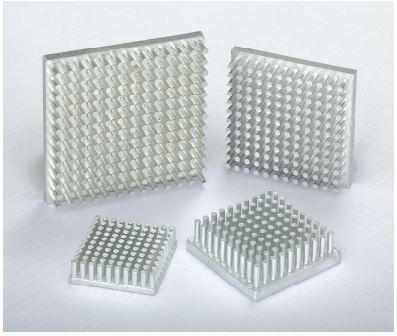
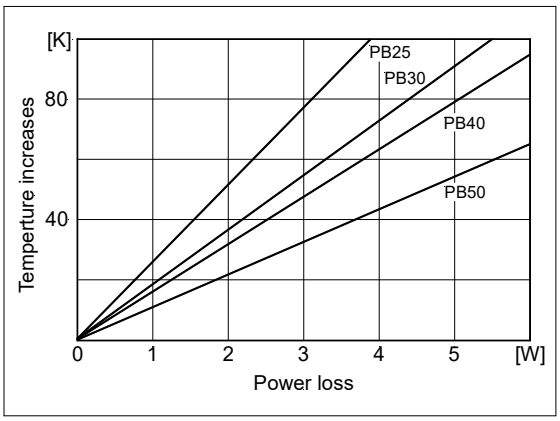
PB Series

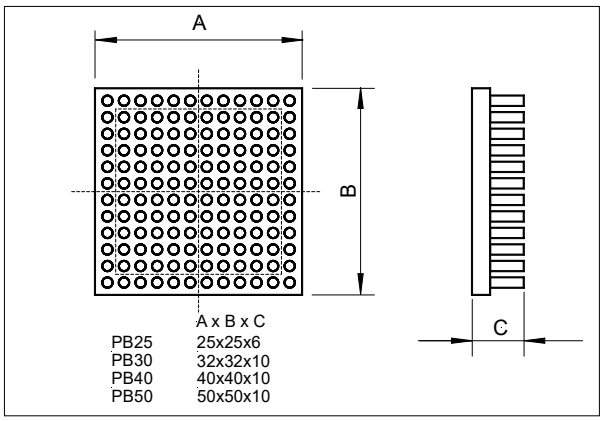
Heat sink with pin pattern



COOLING PERFORMANCE



SHAPE and DIMENSION



PERFORMANCE

CE	PB25-06	PB32-10	PB40-10	PB50-10
Typ. thermal resistance [K/W]	39	24	15,9	12,5
Weight [g]	6	17	24	36
Standard packing quantity [Pcs]	50-100-500	50-100-500	50-100-500	40-100-500

The values for thermal resistance are valid for vertically standing heat sinks in stationary air.

These ***SEPA***® high-tech pin pattern heat sinks, made from pure aluminum Al99.5 are very suitable for cooing of small electronic components. The extrusion process ensures optimum heat distribution in the base plate and in the pins.

Due to the low weight the heat sinks could be mounted by simple gluing with a double adhesive and thermally conductive foil (TCTxx) or a rapid-curing two-component adhesive (HERNON 476).

• ORDER INFORMATION

PB25-25-6.5-100-AL-2	***SEPA***® pin pattern heat sink, 25x25x6mm, **CE**	111111189
PB32-32-10-100-AL-2	***SEPA***® pin pattern heat sink, 30x30x10mm, **CE**	111111165
PB40-40-10-144-AL-2	***SEPA***® pin pattern heat sink, 40x40x10mm, **CE**	111111166
PB50-50-10-169-AL	***SEPA***® pin pattern heat sink, 50x50x10mm, **CE**	111111167

More dimensions, shapes and surfaces auf Anfrage

Technical changes without notice • 11/16